



更改 REV	設變內容 MODIFICATION	日期 DATE	修改 DRAW

ITEM	DESCRIPTION	Q'TY	MATERIAL	TREATMENT
①	SHELL	1	COPPER ALLOY	AU FLASH PLATING
②	HOUSING	1	H-TEMPERATURE THERMOPLASTIC UL 94V-0	MOLDED BLACK
③	CONTACT	8	COPPER ALLOY	CONTACT AREA: AU 10u" MIN PLATING SOLDERTAIL AREA: AU FLASH PLATING

Note:

1. Material:

1.1 Contact: Phosphorous Bronze

1.2 Shell Material: Copper Alloy 0.30±0.02, with 100u" Ni Plated

1.3. Insulator Material: High Temperature Thermoplastic UL 94V-0

1.4. Contact Area: 30u" Min. Ni Over 10u" Au., 50u" Min Sn/Pb In Solder Tail Area.

2. Rating:

2.1. Voltage: 30 VAC (R.M.S).

2.2. Current : 1.0 A Max. Per Contact At 30°C T-Rise.

2.3. Temperature: -55°C To +85°C.

3. Electrical Specification:

3.1. Contact Resistance: 30 MilliOhms Max. Initial.

3.2. Insulation Resistance: 1,000 MegaOhms Min.

3.3. Dielectric Withstanding Voltage: 750 VAC At Sea Level.

DIMENSION IN mm [Inch]	
TOLERANCE UNLESS OTHERWISE SPECIFIED	
.X±0.3	X'± 1'
.XX±0.20	.X'± 0.5'
.XXX±0.100	.XX'± 0.25'

康茂股份有限公司
COMMA ELECTRONIC INC.

名稱
TITLE Mini USB 8 Pin Socket

案號
FILE NO. MUSO.45-1108

圖號
DWG No. MUSO.45-1108

圖紙
SIZE A4

角法
PROJ. 第一角

日期
DATE 05/05/04

比例
SCALE 1:1

更改
REV A

CUSTOMER DRAWING

F
E
D
C
B
A

F
E
D
C
B
A

1 2 3 4 5 6 7 8